

UF1000CT~UF1006CT

ULTRAFAST RECOVERY RECTIFIERS

VOLTAGE 50 to 600 Volts **CURRENT** 10.0 Amperes

TO-220AB

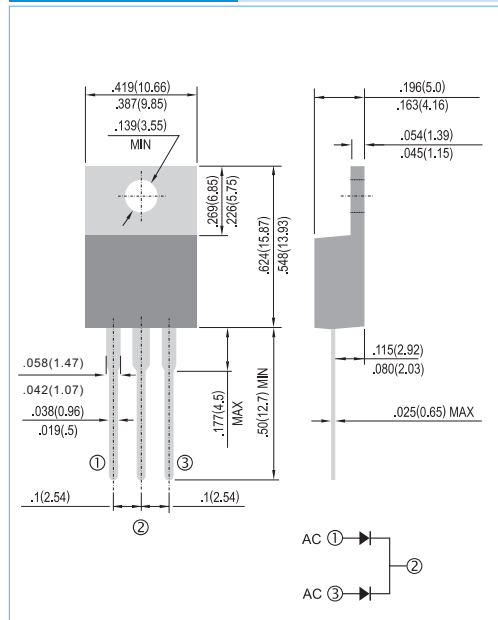
Unit: inch (mm)

FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-O utilizing Flame Retardant Epoxy Molding Compound.
- Exceeds environmental standards of MIL-S-19500/228
- Low power loss, high efficiency.
- Low forward voltage, high current capability
- High surge capacity.
- Ultra fast recovery time, high voltage.
- In compliance with EU RoHS 2002/95/EC directives

MECHANICAL DATA

- Case: TO-220AB full molded plastic package
- Terminals: Lead solderable per MIL-STD-750, Method 2026
- Polarity: As marked.
- Standard packaging: Any
- Weight: 0.0655 ounces, 1.859 grams.



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

PARAMETER	SYMBOL	UF1000CT	UF1001CT	UF1002CT	UF1003CT	UF1004CT	UF1006CT	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	300	400	600	V
Maximum RMS Voltage	V_{RMS}	35	70	140	210	280	420	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	300	400	600	V
Maximum Average Forward Current at $T_C = 100^{\circ}\text{C}$	$I_{F(AV)}$	10						A
Peak Forward Surge Current :8.3ms single half sine-wave superimposed on rated load(JEDEC method)	I_{FSM}	125						A
Maximum Forward Voltage at 5.0A	V_F	1.0			1.30		1.70	V
Maximum DC Reverse Current $T_J=25^{\circ}\text{C}$ at Rated DC Blocking Voltage $T_J=125^{\circ}\text{C}$	I_R	1.0 500						μA
Typical Junction Capacitance (Note 1)	C_J	60					40	pF
Maximum Reverse Recovery Time (Note 2)	t_{rr}	50					100	ns
Typical Thermal Resistance (Note 3)	$R_{\theta JC}$	2						$^{\circ}\text{C} / \text{W}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150						$^{\circ}\text{C}$

NOTES:

- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- Reverse Recovery Test Conditions: $I_F=.5\text{A}$, $I_R=1\text{A}$, $I_{rr}=.25\text{A}$.
- Thermal resistance from Junction to case.
- Both Bonding and Chip structure are available.

UF1000CT~UF1006CT

RATING AND CHARACTERISTIC CURVES

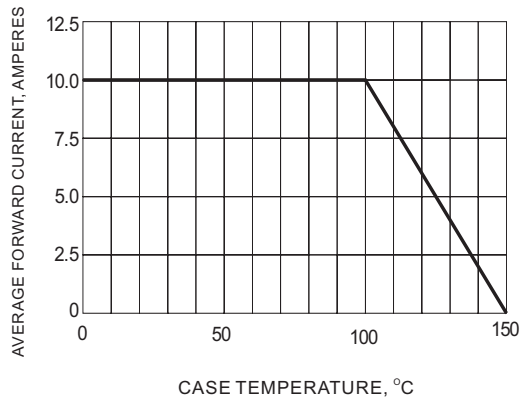


Fig.1 FORWARD CURRENT DERATING CURVE

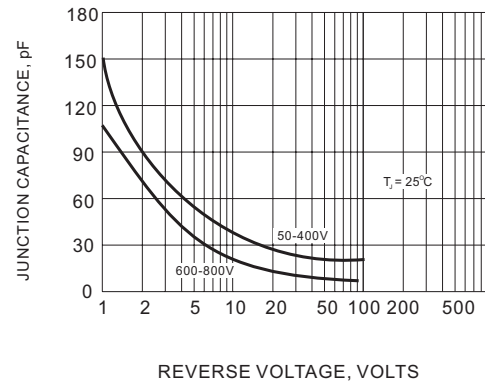


Fig.2 TYPICAL JUNCTION CAPACITANCES

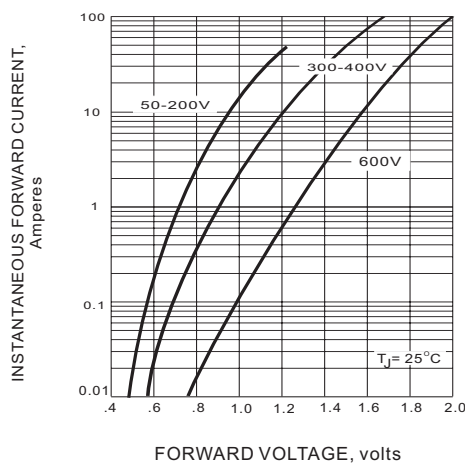


Fig.3 FORWARD CHARACTERISTICS

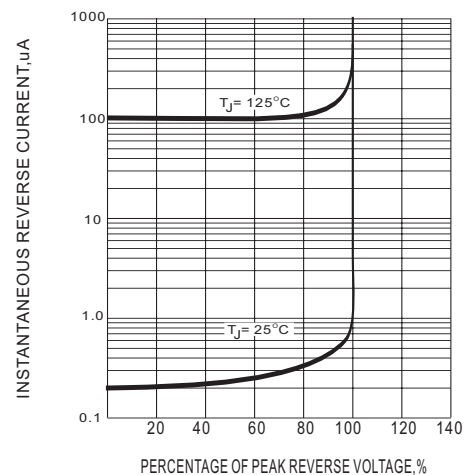


Fig.4 TYPICAL REVERSE CHARACTERISTICS

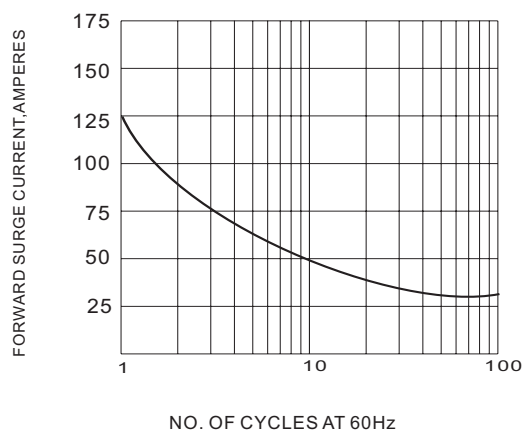


Fig.5 PEAK FORWARD SURGE CURRENT